			*	
L Number	Hits	Search Text	DB	Time stamp
1	7		USPAT;	2002/05/10 13:06
*		or ("6177646") or ("6095083") or	US-PGPUB	
		("5922223") or ("6077384")).PN.	] 00 10102	
	412		HCDAT.	2002/05/10 13:06
-	412	(118/723i).CCLS.	USPAT;	2002/03/10 13:06
			US-PGPUB	
-	240	(156/345.48).CCLS.	USPAT;	2002/05/07 18:12
			US-PGPUB	
-	117	(118/723an).CCLS.	USPAT;	2002/05/07 18:12
			US-PGPUB	
<b>i</b> _	136	118/723i.ccls. and 156/345.48.ccls.	USPAT;	2002/05/08 11:30
i -	130	110/7231.CC13. and 130/343.40.CC13.	EPO; JPO	2002/03/00 11.30
	١	156/045 40 3	1	0000/05/00 11 01
-	41	\	USPAT;	2002/05/08 11:31
		118/723an.ccls.) and ((Faraday adj	EPO; JPO	
		shield))		
-	10	("4659449"   "5105761"   "5134965"	USPAT	2002/05/08 11:50
		"5290993"   "5401350"   "5415728"	1	
		"5522934"   "5614055"   "5753044"		
		"5777289").PN.		
_	5		USPAT	2002/05/08 11:52
	3		JOIAI	2002/03/00 11:32
	1	"5753044"   "5777289").PN.	l manam	2002/05/02 33 55
-	192		USPAT;	2002/05/08 11:57
		118/723an.ccls.) and (shield (Faraday adj	EPO; JPO	
		shield))		
-	59310	heat near5 (chamber reactor)	USPAT;	2002/05/08 13:21
		,	EPO; JPO	
_	1	((resist\$3 adj heat\$3) near5 (chamber	USPAT;	2002/05/08 13:23
	_		EPO; JPO	2002/03/00 13.23
		reactor)) and ((118/723i.ccls. or	EFO, UPO	
		156/345.48.ccls. or 118/723an.ccls.) and		
		(shield (Faraday adj shield)))		/
-	384		USPAT;	2002/05/08 14:31
		reactor)	EPO; JPO	
-	125	(resist\$3 adj heat\$3) near5 (chamber	USPAT;	2002/05/08 13:29
		reactor) and (vapor adj deposition)	EPO; JPO	
_	259	((resist\$3 adj heat\$3) near5 (chamber	USPAT;	2002/05/08 14:05
		reactor)) not ((resist\$3 adj heat\$3) near5	EPO; JPO	= = = = = = = = = =
		(chamber reactor) and (vapor adj		
	1 12	deposition))	IICDAM	2002/05/00 14:00
-	12		USPAT	2002/05/08 14:22
-	165	(heat\$3 adj wire) near5 (chamber reactor)	USPAT;	2002/05/08 14:33
			EPO; JPO	
-	164	((heat\$3 adj wire) near5 (chamber	USPAT;	2002/05/08 16:03
		reactor)) not ((resist\$3 adj heat\$3) near5	EPO; JPO	
		(chamber reactor))		
-	1440	1 '	USPAT;	2002/05/08 16:21
			EPO; JPO	
	30	118/724.ccls. and (heat\$3 adj wire)	USPAT;	2002/05/09 08:49
		125, 121.0020. and (modely) day wife,	EPO; JPO	
_	10	4958592.URPN.		2002/05/08 16:17
-	12	1	USPAT	
-	20	118/724.ccls. and 118/723i.ccls.	USPAT;	2002/05/08 16:49
			EPO; JPO	
-	6	("5001113"   "5365057"   "5401350"	USPAT	2002/05/08 16:37
		"5556501"   "5614055"   "5865896").PN.		
_	1085		EPO; JPO	2002/05/08 16:56
_	4	c23c016/48.ipc. and ((heat\$3 adj wire)	EPO; JPO	2002/05/08 16:51
	j	(resistive adj heat) (resist\$ adj heat))		-552, 55, 55 10.51
_	1 =		EDO. TOO	2002/05/00 16.57
-	15	1	EPO; JPO	2002/05/08 16:57
		materials".as.		0000/05/00 15 ==
-	4	5690050.URPN.	USPAT	2002/05/08 17:17
-	317	1	USPAT;	2002/05/09 10:09
		element)(resist\$3 adj heat\$3) heat) near5	EPO; JPO	
		(chamber reactor))		
_	109	156/345.37.ccls.	USPAT;	2002/05/09 10:24
			EPO; JPO	
_	114	156/345.37.ccls.	USPAT;	2002/05/09 14:22
	114	150/543.57.6613.	·	2002/03/03 14.22
			US-PGPUB;	
		110/705 3-	EPO; JPO	0000/05/00 1: 5=
-	1963	118/725.ccls.	USPAT;	2002/05/09 14:23
			US-PGPUB;	
			EPO; JPO	<u> </u>

Page 1

			•	
-	2:	3 118/725 ccls and //woright2 - 1		
	1 -	1 == -,	USPAT;	2002/05/09 14:2
		(heat\$3 adj wire) near5 (substrate	US-PGPUB;	14.2
_	1 .	workpiece wafer))	EPO; JPO	
		1 0, 20,0015, did ((resists) and heat)	USPAT:	2002/05/09 14:3
		(Meacy) dd   Wire)   near5(substrate	US-PGPUB;	2002/03/09 14:30
	389	WOLKPiece Wafer)	EPO; JPO	İ
	309	I '''- CO-SCYO QUI NEATI (Neatis and)	USPAT;	2002/05/09 16:28
		near5(substrate workpiece wafer))	US-PGPUB;	2002/03/09 16:28
_	2		EPO; JPO	1
	1 2	1 101-02-17 Y 1 1 DC . dll() (7/10/11 6/5/15/6/15/6/1	USPAT;	2002/05/00 14
		(((tesist)) add heat) (heats) add	US-PGPUB;	2002/05/09 14:41
-	1	Heard (Substrate Workpiece Wafer)	EPO; JPO	
	11	C23CU16/\$.ipc. and (((resists) add boot)	USPAT;	2000/05/00
	İ	(Meacy) dul Wire)) near5/substrate	US-PGPUB;	2002/05/09 14:43
-		WOLKPiece Waler))	EPO; JPO	
	53	(h011021/\$.ipc.) and (((resists3 add boot)	USPAT;	000045545
		(medicas dd) Wire)) near5(substrate		2002/05/09 14:55
		workpiece water))	US-PGPUB;	1
_	7941	(substrate workpiece wafer) adj conductive	EPO; JPO	
		i are marely and conductive	USPAT;	2002/05/09 16:30
			US-PGPUB;	
_	26835		EPO; JPO	
		conductive "dreif hear	USPAT;	2002/05/09 16:29
			US-PGPUB;	
-	85726	vapor adj deposition	EPO; JPO	
	1	5 = -F-02-01011	USPAT;	2002/05/09 16:30
			US-PGPUB;	1
-	3206	(vapor adj deposition) and ((substrate	EPO; JPO	1
		workpiece wafer) near conductive)	USPAT;	2002/05/09 16:30
İ		remprese water, hear conductive)	US-PGPUB;	
	2	156/345 48 and //outseture	EPO; JPO	
	_	156/345.48 and ((substrate workpiece wafer) adj conductive)	USPAT;	2002/05/09 16:31
		"azer, ad] conductive)	US-PGPUB;	
	9	156/345 49 and //miles	EPO; JPO	
	1	156/345.48 and ((substrate workpiece wafer) near conductive)	USPAT;	2002/05/09 16:31
		"drei, Hear Conductive)	US-PGPUB;	10.51
			EPO; JPO	•

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